9/14/04

09-23-2004

Form PTO-1595 (Rev. 03/01)	U.S. DEPARTMENT OF COMMERCE U.S. Patent and Trademark Office	
	02842499	
To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof		
Name of conveying party(ies):	2. Name and address of receiving party(ies)	
1. Hiroshi TAYANAKA (09/02/04)	Name: Sony Corporation	
	Internal Address:	
	Street Address:	
Additional name(s) of conveying party(ies) attached? Yes	X No 7-35 Kitashinagawa Shinagawa-Ku, Tokyo	
3. Nature of Conveyance:	Cimagana (a,) onyo	
x Assignment Merger		
Security Agreement Change of	Name City: Tokyo	
Other	State: <u>Japan</u> Zip: <u>141-0001</u>	
Execution Date: See conveying part	y Additional name(s) & Yes X No address(es) attached:	
4. Application number(s) or patent number(s):	:	
If this document is being filed together with a new applie	cation, the execution date of the new application is: 09/02/04	
A. Patent Application No.(s):	B. Patent No.(s):	
Additional num	nbers attached? Yes x No	
Name and address of party to whom correspondence concerning document should be mailed:	ondence 6. Total number of applications and patents involved:	
Name: Ronald P. Kananen		
RADER, FISHMAN & GRAUER PLLC	7. Total fee (37 CFR 3.41) \$ 40.00	
Internal Address:	Enclosed	
Street Address: 1233 20th Street, N.W.	x Authorized to be charged to deposit account	
Suite 501	Authorized to be charged to credit card (Form 2038 enclosed)	
	8. Deposit account number:	
City: State: Zip: Washington DC 20036	18-0013	
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9. Statement and signature.		
To the best of my knowledge and belief, the form is a true copy of the original document.	pregoing information is true and correct and any attached copy	
Ronald P. Kananen - 24,104	September 14, 2004	
Name of Person Signing	// Signature Date	
Total number of pages including cove	er sheet, attachments, and documents:3	
		
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> PATENT REEL: 015801 FRAME: 0803

Docket Number:	SON-3080
Docker Hailibel.	

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in PROCESS FOR FABRICATING A THIN FILM SEMICONDUCTOR DEVICE. THIN FILM SEMICONDUCTOR

DEVICE, AND LIQUID CRYSTAL DISPLAY

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto:

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this this application in the spaces that follow: Serial Number:	
This assignment executed on the dates indicated below.	
Hiroshi TAYANAKA	
Name of first or sole inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of first or sole inventor Thirsohi Tayan alea	2005/9/2
Signature of first or sole inventor	Date of this assignment

RECORDED: 09/14/2004

PATENT REEL: 015801 FRAME: 0804